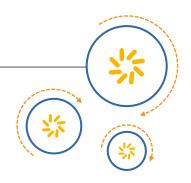


# RF360 Europe GmbH

A Qualcomm - TDK Joint Venture



# **SAW** components

# SAW RF filter for base station

Series/type: B5114

Ordering code: B39781B5114U410

Date: June 08, 2016

Version: 2.4

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#### SAW RF filter for base station

781.5

#### Data sheet

#### 1 Application

- RF filter for base station
- Unbalanced to unbalanced operation
- Low amplitude ripple
- Usable pass band 11 MHz
- $\blacksquare$  No matching required for operation at 50  $\Omega$

#### 2 Features

- Package code DCC6C
- Package size 3.0±0.1 mm × 3.0±0.1 mm
- Package height 1.1±0.125 mm
- Approximate weight 0.04 g
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au plated terminals
- Lead free soldering compatible with J-STD20C
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 1 (MSL1)

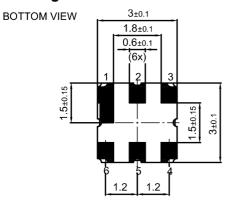


### SAW RF filter for base station

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#### 3 Package

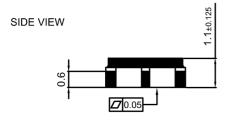


# 4 Pin configuration

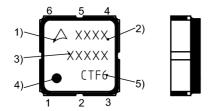
■ 2 Input

■ 5 Output

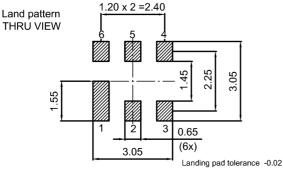
■ 1, 3, 4, 6 Ground



TOP VIEW SIDE VIEW



- 1) Company logo
- 2) Device designation
- 3) Last five digits of the lot number
- 4) Marking for pad number 1
- 5) Example of production location and date code



**Figure 2:** Drawing of package. See Sec. Package information (p. 17).



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# 5 Matching circuit

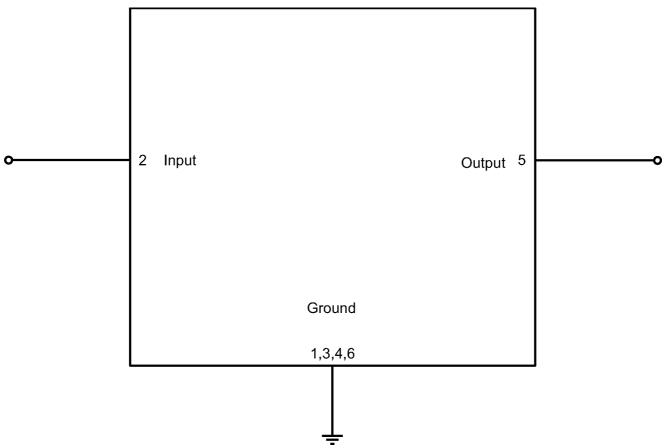


Figure 3: Schematic of matching circuit. No external matching components required.



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### **Characteristics**

Temperature range for specification = -40 °C ... +85 °C

 $T_{ ext{SPEC}} \ Z_{ ext{IN}} \ Z_{ ext{OUT}}$ Input terminating impedance = 50 Ω Output terminating impedance = 50 Ω

Characteristics				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{\tiny SPEC}} \end{array}$	<b>typ.</b> @+25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{\tiny SPEC}} \end{array}$	
Center frequency			f <sub>C</sub>	_	781.5	_	MHz
Maximum insertion attenuation			$\boldsymbol{\alpha}_{\text{max}}$				
	776 787	MHz		_	1.6	2.5	dB
Amplitude ripple (p-p)			Δα				
	776 787	MHz		_	0.6	1.5	dB
Amplitude ripple (in any segment of 5 MHz)			Δα				
	776 787	MHz		_	0.5	0.6	dB
Variation of group delay			$\Delta \tau_{var}$				
	776 787	MHz		_	48	70	ns
Average group delay			$\Delta \tau_{_{\text{avg}}}$				
	776 787	MHz		_	35	70	ns
Maximum VSWR			$VSWR_{max}$				
@ input port	776 787	MHz		_	1.3	1.9	
@ output port	776 787	MHz		_	1.3	1.9	
Minimum attenuation			$\alpha_{_{ m min}}$				
	54 700	MHz	111111	35	40	_	dB
	700 746	MHz		20	30	_	dB
	746 757	MHz		20	28	_	dB
	758 765	MHz		9	23	_	dB
	851 894	MHz		30	44	_	dB
	894 1250	MHz		28	35	_	dB
	1250 2050	MHz		35	50	_	dB
	2050 3800	MHz		10	13	_	dB



B5114 **SAW** components

# SAW RF filter for base station

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Temperature range for specification = −40 °C ... +105 °C

T<sub>SPEC</sub> Input terminating impedance = 50  $\Omega$ Output terminating impedance  $Z_{\mathsf{OUT}}$ = 50 Ω

Characteristics				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	<b>typ.</b> @+25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{SPEC}} \end{array}$	
Center frequency			f <sub>C</sub>	_	781.5	_	MHz
Maximum insertion attenuation			$\boldsymbol{\alpha}_{\text{max}}$				
	776 787	MHz		_	1.6	2.6	dB
Amplitude ripple (p-p)			Δα				
	776 787	MHz		_	0.6	1.6	dB
Amplitude ripple (in any segment of 5 MHz)			Δα				
	776 787	MHz		_	0.5	0.6	dB
Variation of group delay			$\Delta \tau_{\text{var}}$				
	776 787	MHz		_	48	80	ns
Average group delay			$\Delta \tau_{\text{avg}}$				
	776 787	MHz		_	35	80	ns
Maximum VSWR			$VSWR_{max}$				
@ input port	776 787	MHz		_	1.3	1.9	
@ output port	776 787	MHz		_	1.3	1.9	
Minimum attenuation			$\boldsymbol{\alpha}_{\text{min}}$				
	54 700	MHz		35	40	_	dB
	700 746	MHz		20	30	_	dB
	746 757	MHz		20	28	_	dB
	758 765	MHz		5	23	_	dB
	851 894	MHz		30	44	_	dB
	894 1250	MHz		28	35	_	dB
	1250 2050	MHz		35	50	_	dB
	2050 3800	MHz		10	13	_	dB



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#### 7 **Maximum ratings**

Operable temperature	T <sub>OP</sub> = −45 °C +125 °C	
Storage temperature	T <sub>STG</sub> = −45 °C +125 °C	
ESD voltage		
	$V_{ESD}^{1)} = 100 \text{ V (max.)}$	Machine model.
	$V_{ESD}^{2)} = 275 \text{ V (max.)}$	Human body model.
Input power @ input port: 776 787 MHz	P <sub>IN</sub> = 15 dBm	Continuous wave for 5000 h @ 100 °C.

According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses. According to JESD22-A114F (HBM – Human Body Model), 1 negative & 1 positive pulse.



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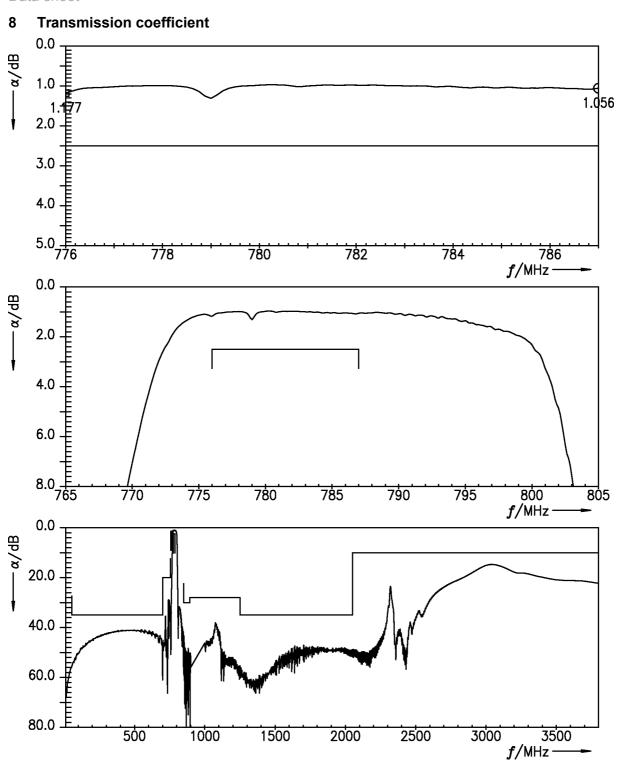


Figure 4: Attenuation.

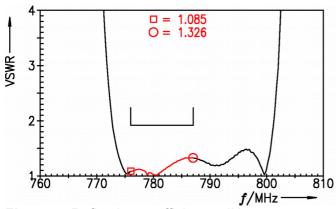


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### 9 Reflection coefficients



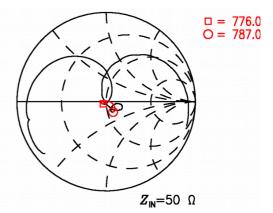
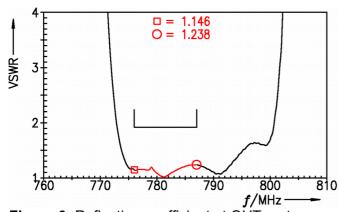


Figure 5: Reflection coefficient at IN port.



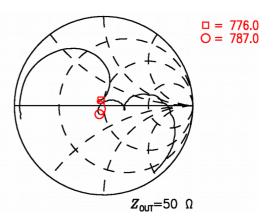


Figure 6: Reflection coefficient at OUT port.



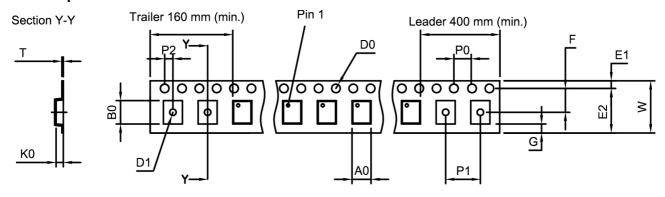
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### 10 Packing material

#### 10.1 Tape



User direction of unreeling

Figure 7: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A <sub>0</sub>	3.25±0.1 mm	E <sub>2</sub>	10.25 mm (min.)	P	4.0±0.1 mm
B <sub>0</sub>	3.3±0.1 mm	F	5.5±0.05 mm	P <sub>2</sub>	2.0±0.1 mm
D <sub>0</sub>	1.5+0.1/-0 mm	G	0.75 mm (min.)	Т	0.2±0.05 mm
D <sub>1</sub>	1.5 mm (min.)	K <sub>0</sub>	1.5±0.1 mm		12.0+0.3/-0.1 mm
E <sub>1</sub>	1.75±0.1 mm	P <sub>0</sub>	4.0±0.1 mm		

Table 1: Tape dimensions.

#### 10.2 Reel with diameter of 180 mm

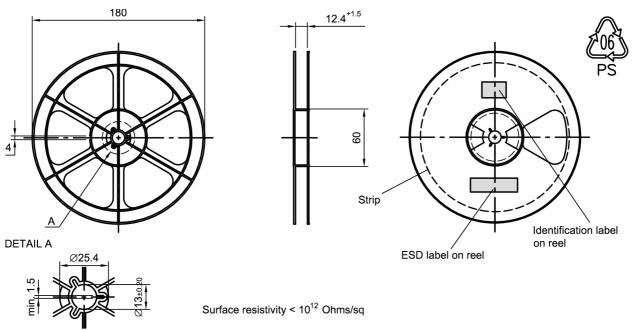


Figure 8: Drawing of reel (first-angle projection) with diameter of 180 mm.



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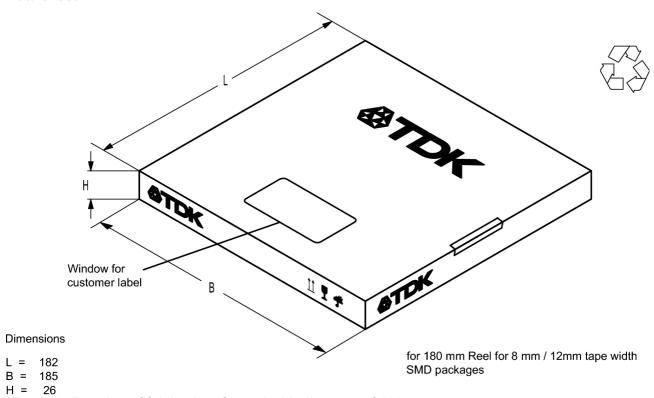
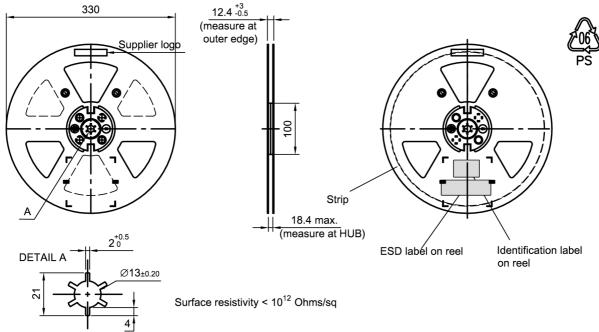


Figure 9: Drawing of folding box for reel with diameter of 180 mm.

#### 10.3 Reel with diameter of 330 mm



**Figure 10:** Drawing of reel (first-angle projection) with diameter of 330 mm.



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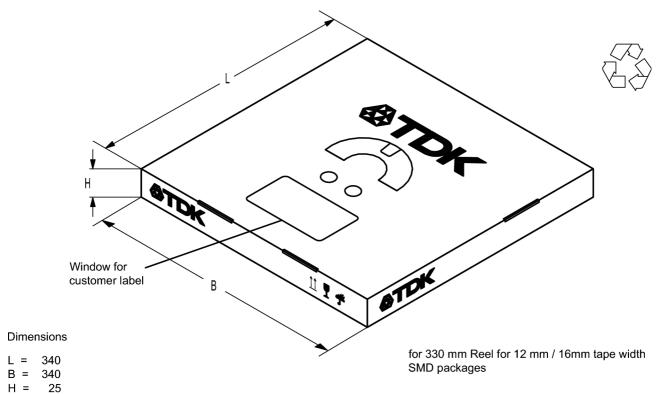


Figure 11: Drawing of folding box for reel with diameter of 330 mm.

#### 11 Marking

Products are marked with device designation, lot number, as well as production location and date code

■ Device designation: The 4-character device designation of the ordering code is used for the marking.

Example for 4-character device designation: B3xxxxB1234xxxx

■ Lot number: The last 5 digits of the lot number are used for the marking.

Example: <u>12345</u>

■ Production location and date code: The production location is Wuxi (encoded in the first character 'C'). The production date code is encoded in the last three characters according to Table 2.



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		1 <sup>st</sup> digi	t (day)				2 <sup>nd</sup> digi	t (year)			3 <sup>rd</sup> digit	(month)	
Day	Code	Day	Code	Day	Code	Year	Code	Year	Code	Month	Code	Month	Code
1	1	11	Α	21	М	2010	Α	2022	Р	Jan	1	Jul	7
2	2	12	В	22	N	2011	В	2023	R	Feb	2	Aug	8
3	3	13	С	23	Р	2012	С	2024	S	Mar	3	Sep	9
4	4	14	D	24	R	2013	D	2025	Т	Apr	4	Oct	0
5	5	15	E	25	S	2014	E	2026	U	May	5	Nov	N
6	6	16	F	26	Т	2015	F	2027	V	Jun	6	Dec	D
7	7	17	Н	27	U	2016	Н	2028	W				
8	8	18	J	28	V	2017	J	2029	Х				
9	9	19	K	29	W	2018	K	2030	Z				
10	0	20	L	30	Х	2019	L	2031	Α				
				31	Z	2020	М	2032	В				
						2021	N	and	so on				

Table 2: Production date code.

Example of how to decode production location and date code:

Code: CTF6

 $\begin{array}{ccccc} \text{Location:} & C & \rightarrow & \text{Wuxi} \\ \text{Day:} & T & \rightarrow & 26^{\text{th}} \\ \text{Year:} & F & \rightarrow & 2015 \\ \text{Month:} & 6 & \rightarrow & \text{June} \\ \end{array}$ 



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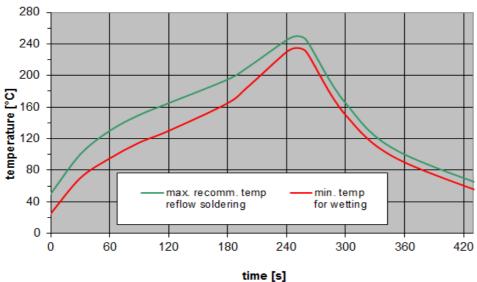
Data sheet

### 12 Soldering profile

The recommended soldering process is in accordance with IEC  $60068-2-58-3^{rd}$  edit and IPC/JEDEC J-STD-020B.

3 K/s 25 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
5 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
s to 70 s
n. 10 s
ax. 20 s
60 °C +0/-5 °C
0 °C +5/-0 °C for 10 s ± 1 s
3 K/s
easured at solder pads
3

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).



**Figure 12:** Recommended reflow profile for convection and infrared soldering – lead-free solder.



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#### 13 Annotations

### 13.1 Matching coils

See TDK inductor pdf-catalog <a href="http://www.tdk.co.jp/tefe02/coil.htm#aname1">http://www.tdk.co.jp/tefe02/coil.htm#aname1</a> and Data Library for circuit simulation <a href="http://www.tdk.co.jp/etvcl/index.htm">http://www.tdk.co.jp/etvcl/index.htm</a>.

# 13.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

#### 13.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local EPCOS sales office.



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#### 14 Cautions and warnings

#### 14.1 Display of ordering codes for EPCOS products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of EPCOS, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under <a href="https://www.epcos.com/orderingcodes">www.epcos.com/orderingcodes</a>.

#### 14.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

#### 14.3 Moldability

Before using in overmolding environment, please contact your local EPCOS sales office.

#### 14.4 Package information

#### Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on EPCOS internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of EPCOS, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

#### **Dimensions**

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

#### **Projection method**

Unless otherwise specified first-angle projection is applied.



#### Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
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